

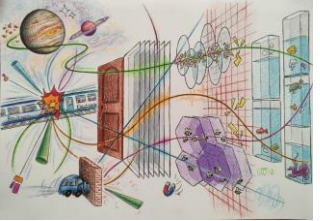
WG3: Radiation Damage & Extreme Fluences

Introduction to the WP – Scope – Community - Resources

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on behalf of the DRD3 proposal writing team



WG3: Community composition

DRD3

Status: 19.3.2023 [88 institutes]

[*] Not all institutes provided numbers

No new strategic R&D included

[**] Extracted from research interest description in survey

WG3 : radiation damage & ultrahigh fluences

- **54 institutes** (61% of 88*) allocated FTEs to the “radiation damage studies” theme in the survey

- Indicated FTE*: **39 FTE senior** personnel and **48 FTE post-doc, students**

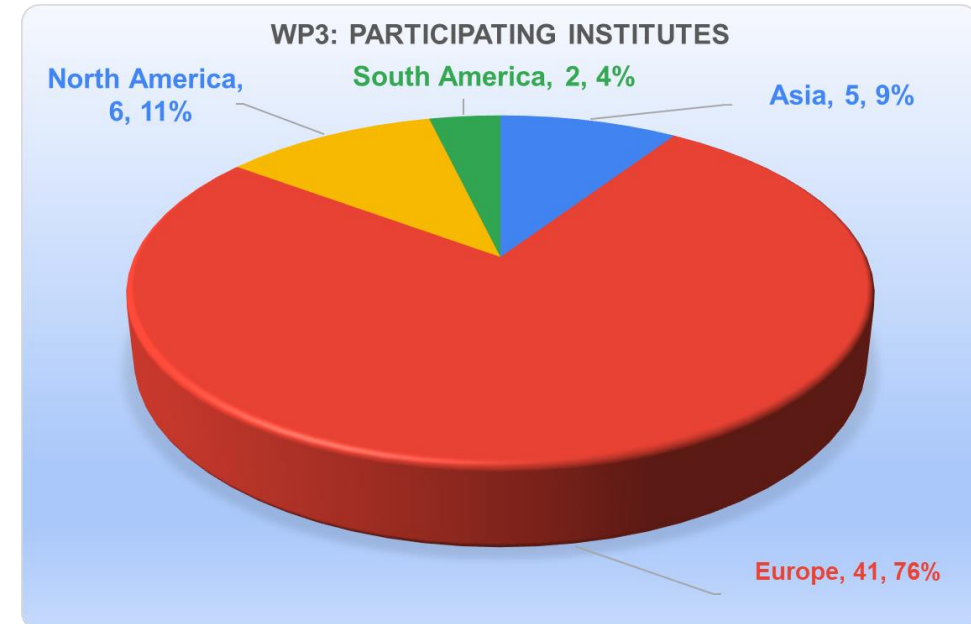
- **54 institutes**

- from 4 different continents

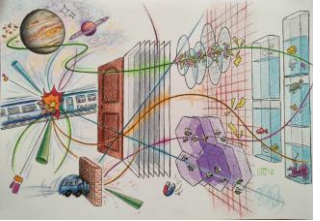
Asia, Europe,
North America, South America

- from 26 different countries

Brazil, Canada, Chile, Croatia, Czech Republic, Finland,
France, Germany, India, Israel, Italy, Japan, Lithuania,
Montenegro, Netherlands, Poland, Romania, Slovenia, Spain,
Switzerland, Türkiye, UK, USA



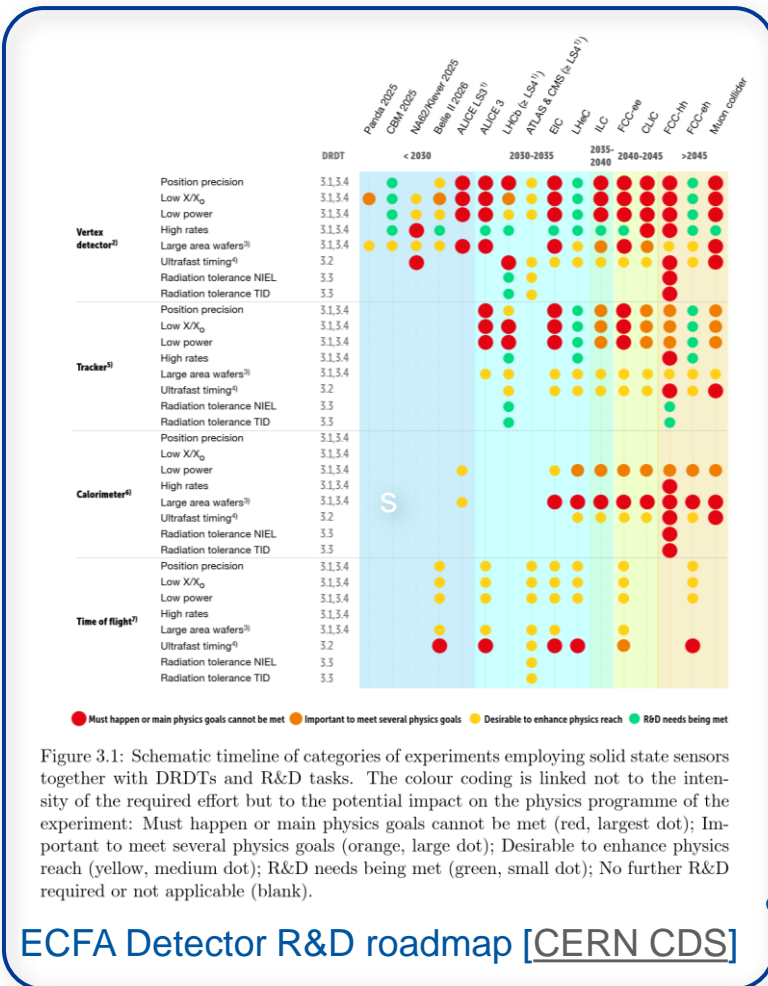
- A large part of the “DRD3 community” ($\approx 80\text{-}90\%$) is interested in radiation damage tests or studies**



WG3: Needs for radhard devices

DRD3

- Technology need and timeline evaluated during ECFA roadmap process



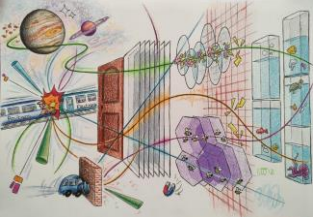
		DRDT	Panda 2025	CBM 2025	NA62/Kleier 2025	Belle II 2026	ALICE LS3 ¹⁾	ALICE 3	LHCb (≥ LS4 ¹⁾)	ATLAS & CMS (≥ LS4 ¹⁾)	EIC	LHeC	ILC	FCC-ee	CLIC	FCC-hh	FCC-eh	Muon collider
			< 2030			2030-2035			2035-2040			2040-2045			>2045			
Vertex	Radiation tolerance NIEL	3.3																
	Radiation tolerance TID	3.3																
Tracker	Radiation tolerance NIEL	3.3																
	Radiation tolerance TID	3.3																
Calorimeter	Radiation tolerance NIEL	3.3																
	Radiation tolerance TID	3.3																
Time of flight	Radiation tolerance NIEL	3.3																
	Radiation tolerance TID	3.3																

● Must happen or main physics goals cannot be met ● Important to meet several physics goals ● Desirable to enhance physics reach ● R&D needs being met

LHCb (≥ LS4)
 $6 \times 10^{16} n_{eq}/cm^2$, 10 MGy

FCC-hh
 $1 \times 10^{18} n_{eq}/cm^2$, 300 MGy

ATLAS & CMS (≥ LS4)
 $6 \times 10^{16} n_{eq}/cm^2$, 5 MGy



WG3: Recommendations for DRDT 3.3. DRD3

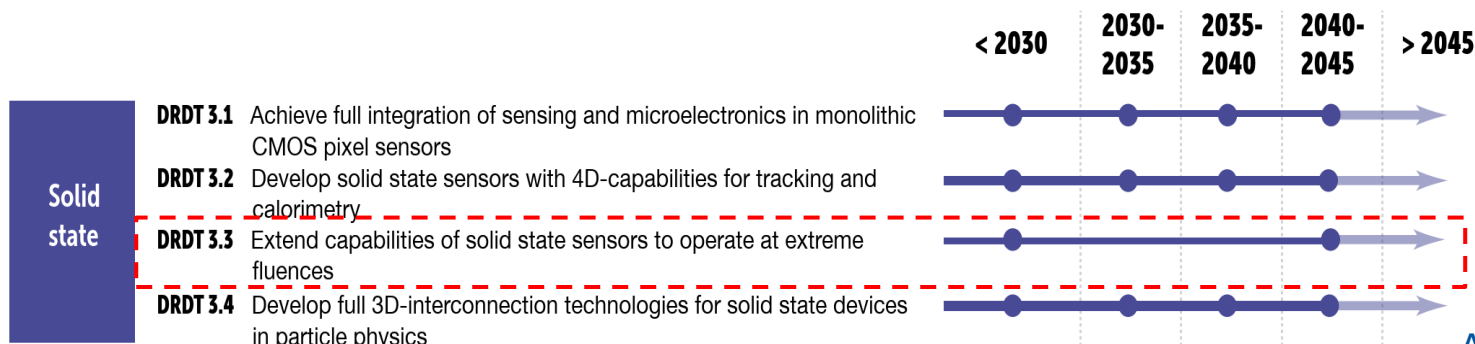
ECFA R&D Roadmap

DRDT 3.3.
Extend capabilities of solid state sensors to operate at extreme fluences

Recommendations have been defined for DRDT3.3. and are fully in-line what we will propose:

ECFA Detector R&D roadmap [CERN CDS]

DETECTOR RESEARCH AND DEVELOPMENT THEMES (DRDTs) & DETECTOR COMMUNITY THEMES (DCTs)



DRDT 3.3 - Sensors for extreme fluences.

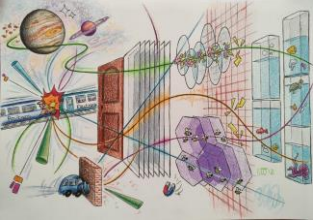
- Measure the properties of silicon sensors in the fluence range $1 \times 10^{16} \text{ n}_{\text{eq}} \text{ cm}^{-2}$ to $1 \times 10^{18} \text{ n}_{\text{eq}} \text{ cm}^{-2}$. Map the limit of 3D sensors and evolve their design to cope with the highest possible fluences;
- Optimise the simulation models with the measurements at high fluence;
- Develop simulation models based on microscopically measured point and cluster defects (instead of a model based on “effective trap levels”);
- Explore the use of WBG semiconductors as radiation detectors at high fluences;
- Develop innovative 2D-materials that can offer high radiation hardness and operate at room temperature.

Activity shared within DRD3

with WG1 & WG2 sensors

with WG4 Simulation

with WG6: Non-silicon materials



WG3: Expression of interest

DRD3

Status: 19.3.2023 [88 Institutes]
Extracted from free text research
interest description in survey

• Evaluate and/or improve radiation hardness of sensors [$\approx 85\%$]

- CMOS, LGAD, 3D, planar,
(i.e. study radiation hardness of existing and newly developed sensor concepts)

see also
WG1 & WG2 on
sensors

• Explore the **extreme fluence** regime and/or study **radiation damage to WBG** sensors [$\approx 65\%$]

- Radiation damage up to extreme fluences (40 Institutes, 45%)
- Radiation hardness of new materials (SiC: 26%, Diamond 17%, GaN 14%, Other 8%)

see also WG6 on
WBG materials

• Study the radiation induced formation of **microscopic defects** and defect properties [$\approx 10\%$]

- Defect spectroscopic measurements (10 Institutes, 11%)

see also WG5 on
characterization
tools

• Produce models to simulate radiation damage on **material level** [$\approx 10\%$]

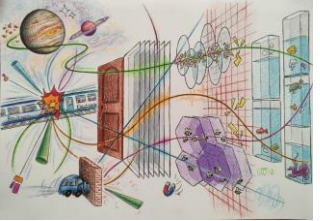
- Modelling of primary damage (Geant4, SRIM, NIEL,...) (6 institutes)
- Modelling of defect kinetics and defect engineering approaches (4 institutes)

• Produce models to simulate radiation damage on **sensor level** [$\approx 17\%$, 15 Institutes]

- Produce/Improve sensor damage parameterization models (i.e. like "Hamburg model")
- Produce reliable TCAD models with defects to simulate radiation damaged sensors

see also
WG4 on
simulations

Note: Number of institutes that want to use simulation tools (TCAD/MC/...) including radiation damage but not necessary want to develop the damage models itself is much higher (see session on simulation!)



WG3: Structuring of the WG

DRD3

- WG structured in 3 areas for the discussion (and proposal?)
- WG closely related to all other WGs

WG4: Simulations

Need for simulations in all areas

- on the material level
Geant4, TRIM, NIEL, DFT, KMC, ...
- on the device & system level
TCAD, AP2, Signal & MC simulators, generic sensor parameter simulations (e.g. Hamburg model)
- extrapolation to extreme fluences
do models still deliver reliable results?

WG5: Characterization techniques

Need for tools in all areas

- on the material level
EPR, FTIR, PL, DLTS, TSC, ...
- on the device & system level
TCT, CV, IV, IBIC, test-beams,
- extrapolation to extreme fluences
which tools still deliver reliable results?
radiation facilities, ...

WG3: Radiation Damage

Radiation hardening of material

understand fundamental damage process, defect formation, impact of defects on device performance (also non-silicon!), material and defect engineering

Radiation hardening of devices and systems

understand device operation with radiation damage, device engineering

Extreme fluences

understand physics, possibilities for operation of detectors

WG6: Non-silicon based detectors

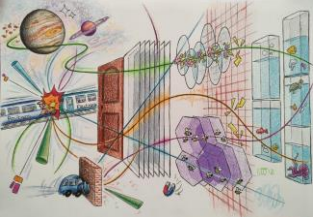
- Material & devices to be studied and understood as silicon in terms of radiation damage in all areas (simulations, material/sensor characterization, tool development)
- Developments for extreme fluence

WG1 & WG2: Silicon based detectors

- Radiation hardness evaluation of all sensors with exposure to radiation (existing and newly developed sensors/sensor concepts)
- Developments for extreme fluence

Synergies with other application areas in radiation fields

- Detectors for nuclear physics, space applications, fusion, medical applications, ...



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Talk: Ioana

Radiation hardening of devices and systems

understand device operation with radiation damage, device engineering

Talk: Sally

Extreme fluences

understand physics, possibilities for operation of detectors

Talk: Marko

WG6: Non-silicon based detectors

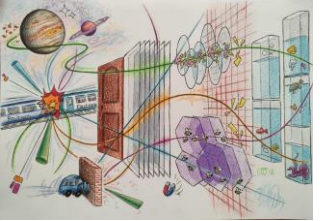
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WP3: Milestones (for discussion)

DRD3

WG3: Radiation Damage

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Extreme fluences

understand physics, possibilities for operation of detectors

• Milestones for 3 years

• Material studies and understanding

- Develop radiation damage models based on microscopically measured point and cluster defects for irradiation fluences up to $10^{16} n_{eq}/cm^2$ [also as input for NIEL and TCAD simulations]
- Develop defect engineered optimized devices: Refine and optimize radiation damage models
- Non-silicon: Build up data sets on defect formation in non-silicon materials

• Devices and systems

- Non-silicon: Build up dataset and produce improved or new models (i.e. parameterizations) for new materials including extreme radiation conditions; transfer of information from models to simulations
- Improve radiation damage models for radiation levels up to the (HL-)LHC operation lifetime
 - sufficient test beam support required for this diverse program!

• Measure the properties of silicon/silicon sensors in the fluence range 10^{16} to $10^{18} n_{eq}cm^{-2}$

- Sensors: Map the operational limits for different device types
- Material: Characterize the defects and the material properties (e.g. carrier mobility)
- Material: Map limits of defect spectroscopic tools and explore/develop tools for extreme fluences
- Deliver input data for models & simulation tools (microscopic and macroscopic level)

• Milestone for 6 years

- reliable availability of facilities for 10^{18} integrated fluence, charged and neutral.